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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/622,464	07/21/2003	Chikaomi Mori	030804	4537
23850	7590 11/29/2004		EXAMINER	
ARMSTRONG, KRATZ, QUINTOS, HANSON & BROOKS, LLP			HOLLINGTON, JERMELE M	
1725 K STREI SUITE 1000	ET, NW		ART UNIT	PAPER NUMBER
	ON, DC 20006		2829	
			DATE MAILED: 11/29/2004	4

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)					
	10/622,464	MORI, CHIKAOMI					
Office Action Summary	Examiner	Art Unit					
	Jermele M. Hollington	2829					
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address					
		0.5004					
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be tim y within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONEI	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on Sept	7 2004						
<u> </u>	action is non-final.						
,—							
•	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims	,						
•	Claim(s) <u>2-8</u> is/are pending in the application.  4a) Of the above claim(s) is/are withdrawn from consideration.						
Claim(s) is/are allowed.							
·							
7)⊠ Claim(s) <u>4-7</u> is/are objected to.							
,—	Claim(s) are subject to restriction and/or election requirement.						
Application Papers							
	nr.						
9) The specification is objected to by the Examiner. 10) The drawing(s) filed on <u>07 September 2004</u> is/are: a) accepted or b) objected to by the Examiner.							
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correct							
11) The oath or declaration is objected to by the E							
Priority under 35 U.S.C. § 119							
	and oriting condens OF LLC C & 440/o	) (d) or (f)					
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a)⊠ All b)□ Some * c)□ None of:  1.⊠ Certified copies of the priority documents have been received.							
<ul><li>1. Certified copies of the priority document</li><li>2. Certified copies of the priority document</li></ul>		ion No					
3. Copies of the certified copies of the prior							
application from the International Burea							
* See the attached detailed Office action for a list		ed.					
	·						
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Attachment(s)	_						
1) Notice of References Cited (PTO-892)	4) Interview Summary						
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date  5) Notice of Informal Patent Application (PTO-1							
Paper No(s)/Mail Date	6) Other:	*					

## **DETAILED ACTION**

1. Applicant's arguments with respect to claims 2-7 have been considered but are moot in view of the new ground(s) of rejection.

## Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 2-3 and 8 are rejected under 35 U.S.C. 102(b) as being anticipated by Hagihara (5825192).

Regarding claim 8, Hagihara discloses [see Fig. 2] a probe card (probe card device 30) used for performing an electrical test of a subject (semiconductor chips 12b) to be tested that is a semiconductor device (wafer 12) or the like and comprising: a substrate body (combination of printed wiring substrate 48 and push mechanism 39); a contactor unit (probe card 32), one surface oriented to face one surface of the substrate body (48) and the other surface of the contactor unit (32) is provided with a plurality of contactors (bump electrodes 33) capable of electrical contact with electrodes (pad electrodes 12a) of the subject (12b)to be tested; an interposer (membrane 33) for establishing an electrical contact between the substrate body (39 and 48) and said contactor unit (32); supporting means (support block 31) for supporting the contactor unit (32) with elastic force; a parallelism adjusting means (bolts 52 and 53) for adjusting a degree of parallelism of the contactor unit (32), wherein a flange section (elastomer

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62) is provided at an outside section of the contactor unit (32), the supporting means (31) is configured to include a support member (support member 50) with a flange section (rod 42) provided at an inside section thereof and arranged to face the flange section (62) of the contactor unit (32) in a vertical direction and include a coil spring (coil spring 45 shown in Fig. 4) interposed between said flange section (420 of the support member (50) and said flange section (62) of the contactor unit (32).

Regarding claim 2, Hagihara discloses a first reinforcing plate (tension imparting block 51) that comes in contact with the substrate body (39) is arranged at the other side [top surface] of the substrate body (39).

Regarding claim 3, Hagihara discloses the support member (50) is attached to the first reinforcing plate (51) via a spacer (rod 42) inserted into a borehole formed on the substrate body (39).

## Conclusion

- 4. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Wood et al (5905382 and 6737882), and Kohno et al (6566150), disclose a method and apparatus for a contactor and semiconductor device.
- 5. Claims 4-7 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.
- 6. The following is a statement of reasons for the indication of allowable subject matter: regarding claims 4, 5 and 7, the instant claims are deemed to be directed to a nonobvious improvement over the admitted prior art of Fig. 4. The improvement comprises heat-conductive

sheet provided between different components to absorb a temperature difference of each component to avoid a warp of the substrate body during testing with high temperature.

Regarding claim 6, the primary reason for the allowance of the claim is due to the fact that probe card has a second reinforcing plate with a screw threadly secured to the plate so as to cause its leading edge to be in contact with a position of the substrate body.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jermele M. Hollington whose telephone number is (571) 272-1960. The examiner can normally be reached on M-F (9:00-4:30 EST) First Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Tokar can be reached on (517) 272-1812. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jehn All Hollington Jermele M. Hollington Patent Examiner Art Unit 2829

JMH November 20, 2004